


Built on PMP9171 RevA PCB

PCB Number: PMP10385
PCB Rev: A

PCB
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Number: PMP10385	Rev: A	Designed for: Public Release	Mod. Date: 9/11/2014
SVN Rev: Not in version control	Assembly Variant: 001	Project Title: Universal AC Input, 12V/0.3A Flyback	Sheet Title:
Drawn By: Sheng-Yang Yu	File: PMP10385_02.SchDoc	Sheet: 1 of 1	Size: B
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